

10/792, 101

| | Type | L # | Hits | Search Text | DBs | Time Stamp | Comments |
|---|------|-----|------|--------------------------|---|------------------|----------|
| 1 | IS&R | L1 | 2454 | (361/760,762,764).CCL S. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB | 2006/08/04 13:49 | |
| 2 | IS&R | L2 | 2761 | (29/832).CCLS. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB | 2006/08/04 13:49 | |
| 3 | IS&R | L3 | 1837 | (257/777).CCLS. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB | 2006/08/04 13:49 | |

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| 4 | BRS | L4 | 117902 | "439"/\$.ccls. | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:50 | |
| 5 | BRS | L5 | 858 | 4 and (sink spread er) and ((integ rated adj circuit) die chip) | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:53 | |
| 6 | BRS | L6 | 771 | 5 and (substr ate board) | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:51 | |

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| 7 | BRS | L7 | 771 | (1 2 3) and (sink spread er) and ((integ rated adj circuit) die chip) | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:51 | |
| 8 | BRS | L8 | 747 | 7 and (substr ate board) | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:52 | |
| 9 | BRS | L9 | 2965 | 4 and (emi (electr omagnet ic adj interfe rence)) | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:54 | |

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| | Type | L # | Hits | Search Text | DBs | Time Stamp | Comments |
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| 10 | BRS | L10 | 75 | 9 and (sink spreade r) and ((integ rated adj circuit) die chip) | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:54 | |
| 11 | BRS | L11 | 2997 | 4 and (emi (farada y adj cage) (electr omagnet ic adj interfe rence)) | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:55 | |
| 12 | BRS | L12 | 77 | 11 and (sink spreade r) and ((integ rated adj circuit) die chip) | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:55 | |

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| | Type | L # | Hits | Search Text | DBs | Time Stamp | Comments |
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| 13 | IS&R | L13 | 2801 | (361/704).CCLS | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:55 | |
| 14 | BRS | L14 | 1186 | 13 and (sink spreader) and ((integrated adj circuit) die chip) | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:55 | |
| 15 | BRS | L15 | 102 | 14 and (emi (faraday adj cage) (electromagnetic interference)) | US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | 2006/08/04 13:55 | |